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	FORM PTO-1595		U.S. DEPARTMENT OF COMMERCE
	e2005 Steas & Halsey LLP	(III)	
	To the Director of the U.S. Patent and Trac	103490793	u.s. PTO
1.	Name of conveying party(ies): (1) Ki-Hwan KIM (2) Jee-Soo MOK (3) Myung-Sam KANG		12/076117 03/13/2008
2.	Name and Address of receiving party SAMSUNG ELECTRO-MECHANICS 314, Maetan3-Dong, Yeongtong-Gu, Gyunggi-Do, KOREA 443-743	CO., LTD.	
3.	Nature of conveyance: X Assignment Security Agreement Other: Execution Date(s): (1), (2), (3), February	Merger Change of Name uary 11, 2008	
4.	Application number(s) or patent num This document is being filed toge		on.
	OR This document is being filed after (a) Patent Application No(s)., file (b) Patent No(s)., issued.		
5.	Name and address of party to whom STAAS & HALSEY LLP Attention: <u>David M. Pitcher</u> 1201 New York Ave., N.W., Suite 70 Washington, D.C. 20005	Our Dock	ing document should be mailed: et: 1937.1182
6.	Total number of applications and pat	ents involved: <u>1</u>	
7.	Total fee (37 CFR 3.41) (\$ 40.00 per Patent or Application in Assignment) ☐ Enclosed ☐ Authorized to be charged to deposit account.		
8.	Deposit Account No.: 19-3935 (Any Account) (Attach duplicate copy of this page if	•	•
	id M. Pitcher , Reg. No. 25,908 ne of Person Signing	Signature	March 13, 2008 Date
	DO	Total number	r of pages including cover sheet: 2
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PATENT REEL: 020687 FRAME: 0721

U.S. ASSIGNMENT

Docket No.

CON 14 64

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

(Insert Name(s) & Address(es) of ASSIGNEE(S))

SAMSUNG ELECTRO-MECHANICS CO., LTD. 314, Maetan3-Dong, Yeongtong-Gu, Suwon, Gyunggi-Do, KOREA 443-743

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled (Title of Invention)

CONDUCTIVE PASTE, PRINTED CIRCUIT BOARD, AND MANUFACTURING METHOD

THEREOF

RECORDED: 03/13/2008

	executed on;	(Insert date of execution of application, if not concurrent)
•) filed on	Any registered attorney of STAAS & HALSEY UP, 1201 New York Avenue, N.W., Sulte 700 Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.
rene	ewal, substitute, reissue or reexamination appli	the United States granted on said application and any continuation, division, cation based thereon, for the full term or terms for which the said Letters ions thereof (collectively, hereinafter, "said application(s) and Letters
enfo Lette prod inclu	SIGNEE, to do all acts which the ASSIGNEE morcing protection for said invention, including in ers Patent(s), in any interference, reissue, reex seeding which may arise or be declared in relat	ed by said ASSIGNEE and without charge to but at the expense of said by deem necessary, desirable or expedient, for securing, maintaining and the preparation and prosecution of said application(s) and the issuance of said amination, or public use proceeding, and in any litigation or other legal ion to same, such acts to include but not be limited to executing all papers, aking all rightful oaths, providing swom testimony, and obtaining and producing
	N WITNESS WHEREOF, the undersigned inve (Typed Name & Signature of Inventor(s))	ntor(s) has (have) affixed his/her/their signature(s). (Dete) (Typed Name & Signature of Witness(es)
1)_	K. H. Kim	Tebruary, 11. 2008
2)_	J. S. Mofe.	Tet. 11. 2008
	14	Feb. 11. 200 J

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